

RoHS

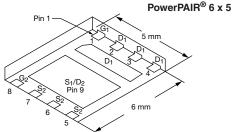
COMPLIANT HALOGEN

FREE

Vishay Siliconix

### Dual N-Channel 30 V (D-S) MOSFETs

PRODUCT SUMMARY							
	V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω)	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)			
Channel 1	20	0.0072 at $V_{GS}$ = 10 V	24 <sup>a</sup>	13.5 nC			
Channel-1	30	0.0092 at V <sub>GS</sub> = 4.5 V	24 <sup>a</sup>	13.5 110			
Channel-2	20	0.0039 at V <sub>GS</sub> = 10 V	28 <sup>a</sup>	34 nC			
Charlfiel-2	30	0.0047 at V <sub>GS</sub> = 4.5 V	28 <sup>a</sup>	34 110			



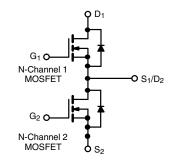
Ordering Information: SiZ900DT-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### FEATURES

- Halogen-free According to IEC 61249-2-21
  Definition
- TrenchFET<sup>®</sup> Power MOSFETs
- 100 % R<sub>g</sub> and UIS Tested
  Compliant to BoHS Directive 5
- Compliant to RoHS Directive 2002/95/EC

#### APPLICATIONS

- Notebook System Power
- POL
- Synchronous Buck Converter



ABSOLUTE MAXIMUM RATINGS (	T <sub>A</sub> = 25 °C, unle	ess otherwise	e noted)		
Parameter		Symbol	Channel-1	Channel-2	Unit
Drain-Source Voltage		V <sub>DS</sub>	30		V
Gate-Source Voltage		V <sub>GS</sub>	±ź	v	
	T <sub>C</sub> = 25 °C		24 <sup>a</sup>	28 <sup>a</sup>	
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C		24 <sup>a</sup>	28 <sup>a</sup>	
Continuous Drain Current $(T_j = 150 \text{ C})$	T <sub>A</sub> = 25 °C	I <sub>D</sub>	19 <sup>b, c</sup>	28 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		15.5 <sup>b, c</sup>	22 <sup>b, c</sup>	А
Pulsed Drain Current		I <sub>DM</sub>	90	110	A
Continuous Source Drain Diode Current	T <sub>C</sub> = 25 °C	- I <sub>S</sub>	24 <sup>a</sup>	28 <sup>a</sup>	
Continuous Source Drain Diode Current	T <sub>A</sub> = 25 °C		3.8 <sup>b, c</sup>	4.3 <sup>b, c</sup>	
Single Pulse Avalanche Current		I <sub>AS</sub>	20	35	
Single Pulse Avalanche Energy L = 0.1 mH		E <sub>AS</sub>	20	61	mJ
	T <sub>C</sub> = 25 °C		48	100	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	PD	31	64	W
	T <sub>A</sub> = 25 °C		4.6 <sup>b, c</sup>	5.2 <sup>b, c</sup>	vv
	T <sub>A</sub> = 70 °C		3 <sup>b, c</sup>	3.3 <sup>b, c</sup>	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		° <b>C</b>
Soldering Recommendations (Peak Temperature) <sup>d,</sup>	e		26	60	°C

THERMAL RESISTANCE RATINGS							
			Char	nel-1	Char	nel-2	
Parameter		Symbol	Тур.	Max.	Тур.	Max.	Unit
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 10 s	R <sub>thJA</sub>	22	27	19	24	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	2.1	2.6	1	1.25	0,11

Notes:

a. Package limited.b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAIR is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 62 °C/W for channel-1 and 55 °C/W for channel-2.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit			
Static						1			
	V	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	Ch-1	30					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	Ch-2	30			V		
V Tomporatura Coofficiant		I <sub>D</sub> = 250 μA	Ch-1		32				
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$ -	I <sub>D</sub> = 250 μA	Ch-2		32		m\//0		
	A)( /T	I <sub>D</sub> = 250 μA	Ch-1		- 6		mV/°C		
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$ -	I <sub>D</sub> = 250 μA	Ch-2		- 6.5				
Cata Thrashold Valtage	Maria	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.2		2.4	v			
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	Ch-2	1		2.2	v		
Gate Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	Ch-1			± 100	nA		
	'688		Ch-2			± 100			
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	Ch-1			1			
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	Ch-2			1			
Zero dale voltage Drain ourrent	.022	$V_{DS}$ = 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C	Ch-1			5	μA		
		$V_{DS}$ = 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C	Ch-2			5			
	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	Ch-1	Ch-1 20			۸		
On-State Drain Current <sup>b</sup>		$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	Ch-2	25			A		
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 19.4 A	Ch-1		0.0059	0.0072			
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$ Ch-2		0.0032	0.0039	0		
Drain-Source On-State Resistance <sup>b</sup>		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 17.2 \text{ A}$	Ch-1		0.0075	0.0092	92 Ω		
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	Ch-2		0.0038	0.0047			
h		$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 19.4 \text{ A}$ Ch			76		_		
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 20 A	Ch-2		120		S		
Dynamic <sup>a</sup>									
Input Capacitance	C <sub>iss</sub>		Ch-1		1830				
input Capacitance	UISS	Channel-1	Ch-2		4900				
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$			300		рF		
	- 035	Channel-2	Ch-2		710				
Reverse Transfer Capacitance	C <sub>rss</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 0 V, f = 1 MHz	Ch-1		120				
•			Ch-2		280				
	-	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 19.4 \text{ A}$	Ch-1		29	45	-		
Total Gate Charge	Q <sub>g</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$	Ch-2		73	110			
	-	Channel-1	Ch-1		13.5	21			
		$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 19.4 \text{ A}$	Ch-2		34	51	nC		
Gate-Source Charge			Ch-1 Ch-2		5.8 15				
		Channel-2	Ch-2 Ch-1		3.1				
Gate-Drain Charge	Q <sub>gd</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$	Ch-2		7.3		-		
			Ch-1	0.5	2.4	4.8			
Gate Resistance	Rg	f = 1 MHz		0.0			Ω		

Notes:

a. Guaranteed by design, not subject to production testing. b. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

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Parameter	Symbol Test Conditions				Тур.	Max.	Unit
Dynamic <sup>a</sup>	•						
Turn-On Delay Time	t <sub>d(on)</sub>	Channel-1	Ch-1		20	40	
	u(on)	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{I}} = 1.5 \Omega$	Ch-2		35	70	
Rise Time	t <sub>r</sub>	$I_D \cong 10 \text{ A}, V_{\text{GEN}} = 4.5 \text{ V}, R_a = 1 \Omega$	Ch-1		10	20	
			Ch-2		10	20	
Turn-Off Delay Time	t <sub>d(off)</sub>	Channel-2	Ch-1 Ch-2		25 35	50 70	
		$V_{DD} = 15 \text{ V}, \text{ R}_{L} = 1.5 \Omega$	Ch-2		10	20	
Fall Time	t <sub>f</sub>	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	Ch-2		10	20	
			Ch-1		15	30	ns
Turn-On Delay Time	t <sub>d(on)</sub>	Channel-1	Ch-2		15	30	
		$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$	Ch-1		10	20	
Rise Time	t <sub>r</sub>	$I_D \cong$ 10 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$	Ch-2		7	15	
	+	Channel-2	Ch-1		30	60	
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{DD} = 15 \text{ V}, \text{ R}_{L} = 1.5 \Omega$	Ch-2		40	80	0  0    0  0    0  0    0  0    0  0    0  0    0  0    0  0    0  0    2  V    0  0    0  0    0  0    0  0    0  0    0  0    0  0    0  0    0  0    0  0    0  0    0  0    0  0    0  0
Fall Time	t <sub>f</sub>	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	Ch-1		10	20	
			Ch-2		10	20	
Drain-Source Body Diode Characteristic	s	1			1	1	1
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C	Ch-1			24	
		_	Ch-2			28	A
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>		Ch-1			90	
		I <sub>S</sub> = 10 A, V <sub>GS</sub> = 0 V	Ch-2 Ch-1		0.8	110 1.2	
Body Diode Voltage	V <sub>SD</sub>	$I_{S} = 10 \text{ A}, V_{GS} = 0 \text{ V}$ $I_{S} = 10 \text{ A}, V_{GS} = 0 \text{ V}$	-			1.2	v
		$I_{\rm S} = 10$ A, $V_{\rm GS} = 0$ V	Ch-2		0.8		
Body Diode Reverse Recovery Time	t <sub>rr</sub>		Ch-1 Ch-2		16 30	30 60	ns
		Channel-1	Ch-2 Ch-1		- 30 - 6	12	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$	Ch-2		21	40	nC
		Channel 0	Ch-1		9		
Reverse Recovery Fall Time	t <sub>a</sub>	Channel-2 I <sub>F</sub> = 10 A, dl/dt = 100 A/μs, T <sub>.I</sub> = 25 °C	Ch-2		17		
		$\mu = 10 \text{ m}, \text{ and } = 100 \text{ m} \mu s, 10 = 20 \text{ O}$	Ch-1		7		ns
Reverse Recovery Rise Time	t <sub>b</sub>		Ch-2		13		1

Notes:

a. Guaranteed by design, not subject to production testing.

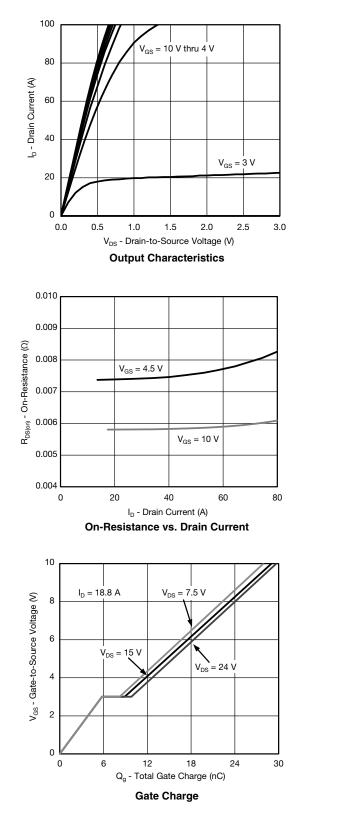
b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

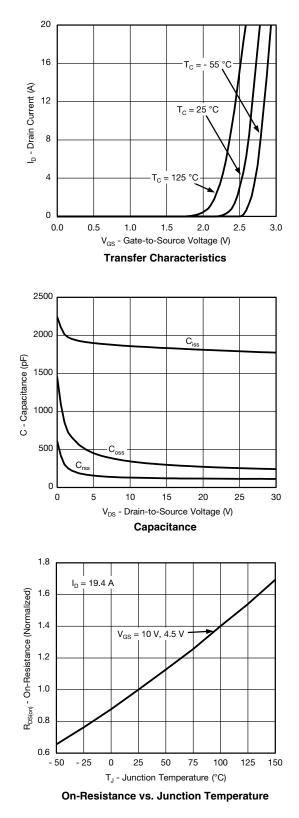
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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#### CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





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T<sub>J</sub> = 125 °C

T<sub>J</sub> = 25 °C

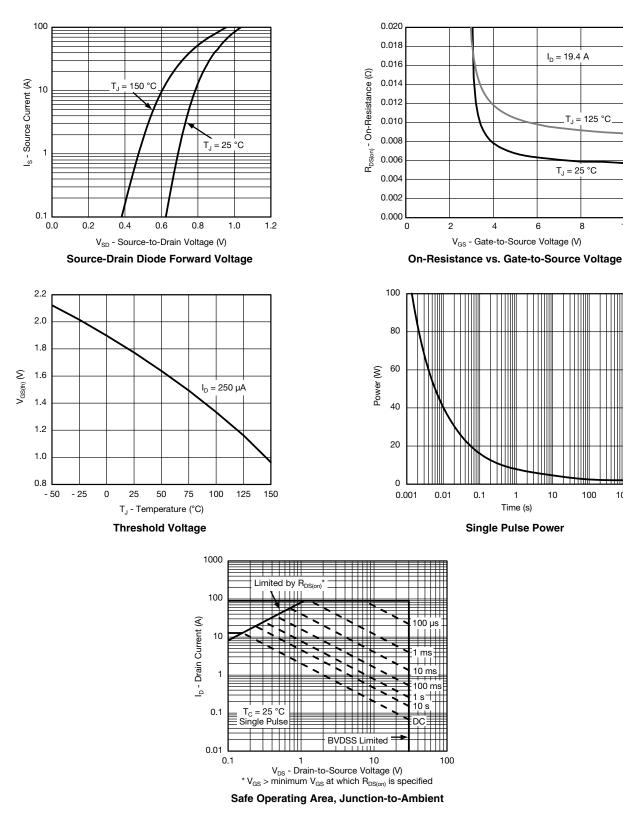
8

100

1000

10

#### CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

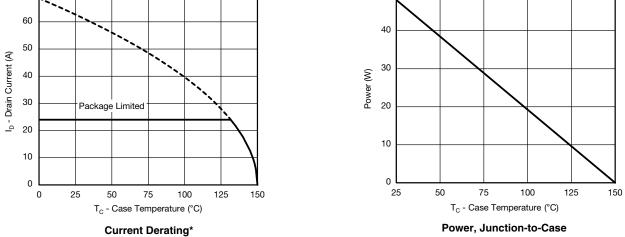


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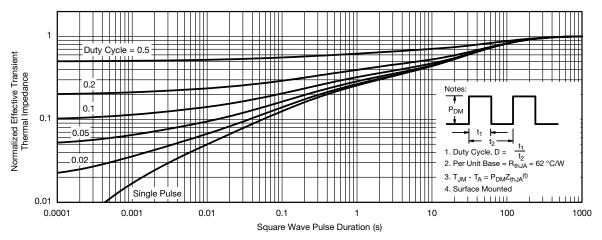


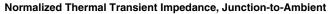


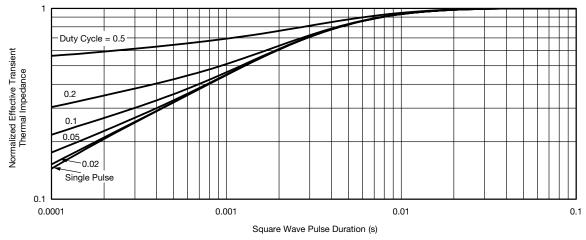
\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



#### CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





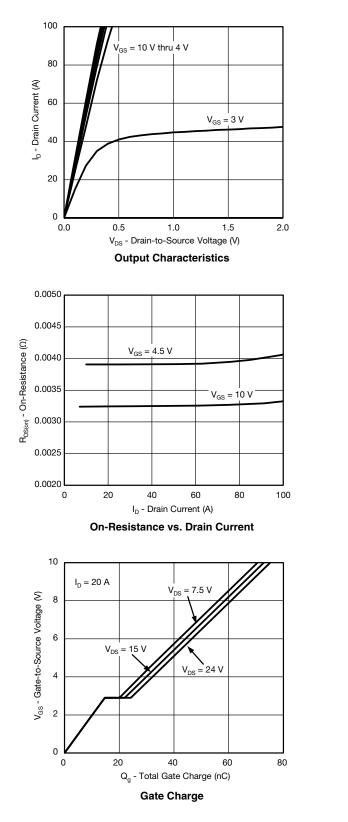


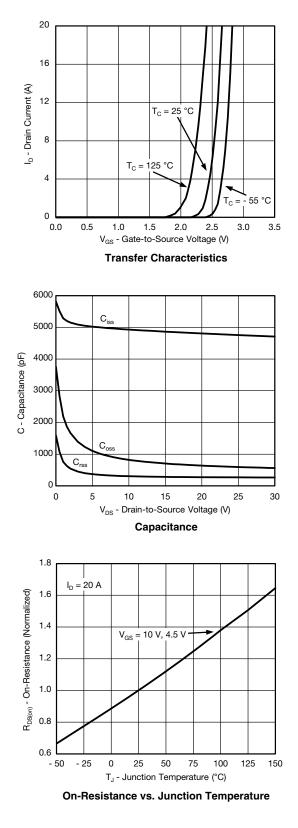
Normalized Thermal Transient Impedance, Junction-to-Case



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#### CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



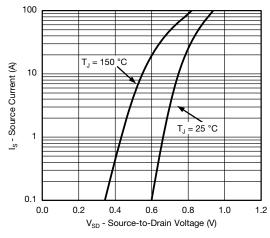


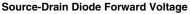
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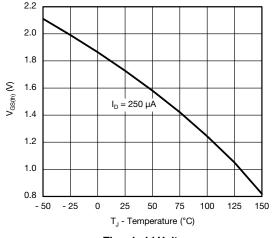
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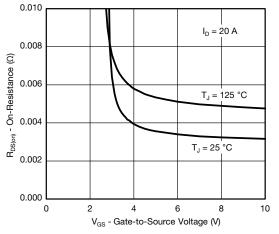
#### CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



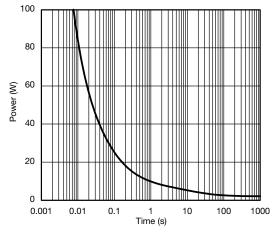




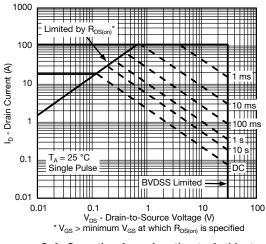




**On-Resistance vs. Gate-to-Source Voltage** 





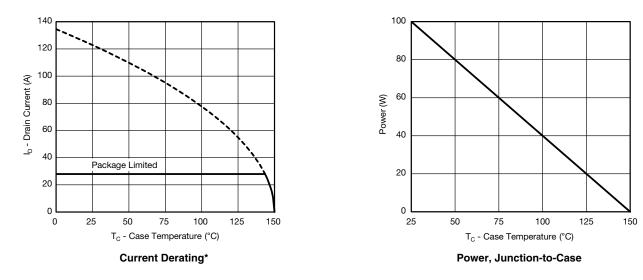


Safe Operating Area, Junction-to-Ambient

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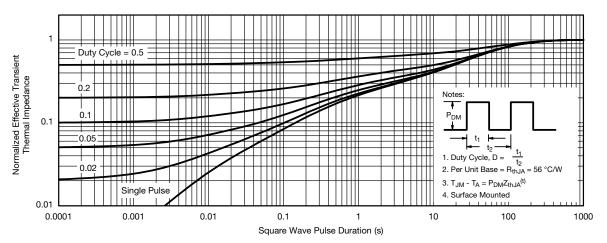


#### CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

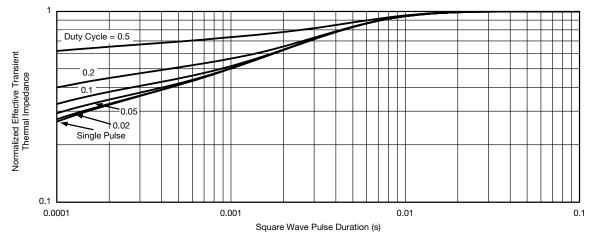
\* The power dissipation P<sub>D</sub> is based on T<sub>J(max)</sub> = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



#### CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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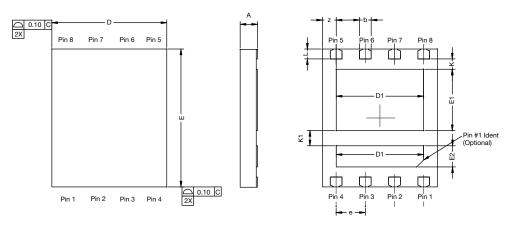
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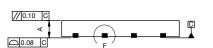


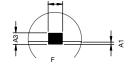
(for SiZ900DT only)



TOP SIDE VIEW

BACK SIDE VIEW





b1

		MILLIMETERS			INCHES				
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.			
А	0.70	0.75	0.80	0.028	0.030	0.032			
A1	0.00	-	0.10	0.000	-	0.004			
A3		0.20 REF			0.008 REF				
b		0.51 BSC							
b1		0.25 BSC 0.010 BSC							
D	5.00 BSC			0.197 BSC					
D1	3.75	3.80	3.85	0.148	0.152				
E	6.00 BSC			0.236 BSC					
E1	2.62	2.67	2.67 2.72 0.103 0.105		0.105	0.107			
E2	0.87	0.92	0.97	0.034	0.036	0.038			
е		1.27 BSC			0.005 BSC				
К		0.45 TYP.			0.018 TYP.				
K1		0.66 TYP.			0.026 TYP.				
L		0.43 BSC			0.017 BSC				
Z	0.34 BSC			0.013 BSC					

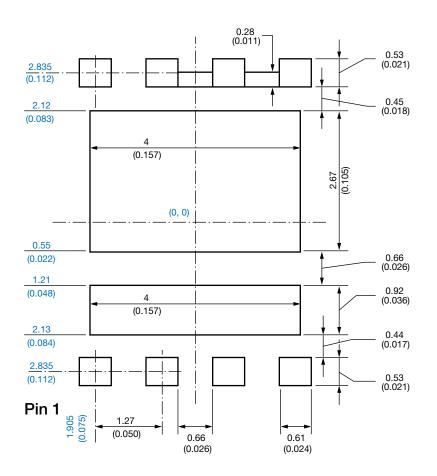
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# Recommended Minimum PAD for PowerPAIR<sup>®</sup> 6 x 5



Dimensions in millimeters (inch)

#### Note

• Linear dimensions are in black, the same information is provided in ordinate dimensions which are in blue.



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